

晶体管光耦

Photo Transistor

QX357X

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概述 Description

QX357X是一款由发光二极管和光电晶体管组成的光电耦合器。四引脚封装（SOP）。

The QX357X is a photoelectric coupler composed of light-emitting diode and phototransistor. It is packaged in a 4-pin small outline SOP package.

特性 Features

- 电流转换比(CTR)范围: 80%~600% ($I_F=5\text{mA}$, $V_{CE}=5\text{V}$, $T_a=25^\circ\text{C}$)
Current transfer ratio: 80%~600% ($I_F=5\text{mA}$, $V_{CE}=5\text{V}$, $T_a=25^\circ\text{C}$)
- 输入-输出隔离电压 ($V_{ISO}=3750\text{ Vrms}$)
High isolation voltage between input and output($V_{ISO}=3750\text{ Vrms}$)
- 集电极-发射极击穿电压 $BV_{CEO}\geq 80\text{V}$
Collector - emitter breakdown voltage $BV_{CEO}\geq 80\text{V}$
- 工作温度: $-55^\circ\text{C}\sim+110^\circ\text{C}$
Operating Temperature: $-55^\circ\text{C}\sim+110^\circ\text{C}$
- 符合加强绝缘标准
Meet reinforced insulation standards
- 符合安规标准: UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5) , CQC11-471543-2022
Meet safety standard approval: UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5) , CQC11-471543-2022

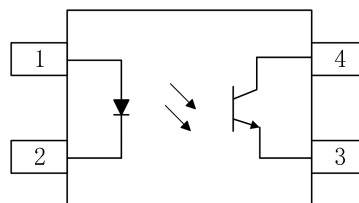
应用 Applications

- 开关电源, 智能电表
Switching power supply, intelligent meter
- 工业控制, 测量仪器
Industrial control, measuring instruments
- 办公设备, 比如复印机
Office equipment such as copiers
- 家用电器, 比如空调、风扇、热水器等
Household appliances: such as air conditioners, fans, water heaters, etc.

封装和原理图 Package and Schematic Diagram



SOP4



Pin Configuration

1. Anode
2. Cathode
3. Emitter
4. Collector

产品型号命名规则 Order Code

QX 357 X - UN Y - W (V) (ZZ)

① ② ③ ④ ⑤ ⑥ ⑦ ⑧

- ① 公司代码 Company Code
- ② 产品系列 Product Series (357)
- ③ CTR 档位 Classification A、B、C、D、E、F 或无 (代码 Code: A、B、C、D、E、F or None)
- ④ 框架类型 Lead Frame (Cu: 铜框架 Copper)
- ⑤ 树脂类型 Epoxy Type (H: 无卤 Halogen-free)
- ⑥ 封装形式 Package (S: SOP)
- ⑦ 器件工作温度范围 Device Operating Temperature Range (特殊范围需填或者空白 Special Range need to be filled in or left blank)
- ⑧ 内部补充代码 Internal Supplementary Code (数字或者空白 Number or Non)

印字信息 Marking Information

- 印字中的“X”代表产品分档：A、B、C、D、E、F 或无
“X” denotes the classification: A、B、C、D、E、F or None
- 印字中“Y”代表年份；A(2018),B(2019),C(2020).....
“Y”denotes YEAR: A(2018), B(2019), C(2020).....
- 印字中“WW”代表周号
“WW”denotes Week's number
- 印字中“N”代表星期几
“N”denotes day of the week
- 印字中的“H”代表无卤
“H”denotes Halogen-free



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绝缘和安规信息 Insulation and Safety related specifications

项目 Item	符号 Symbol	数值 Value	单位 Unit	备注 Remark
爬电距离 Creepage Distance	L	>5.0	mm	从输入端到输出端，沿本体最短距离路径 Measured from input terminals to output terminals, shortest distance path along body
电气间隙 Clearance Distance	L	>5.0	mm	从输入端到输出端，通过空气的最短距离 Measured from input terminals to output terminals, shortest distance through air
绝缘距离 Insulation Thickness	DTI	>0.4	mm	发射器和探测器之间的绝缘厚度 Insulation thickness between emitter and detector
峰值隔离电压 Peak Isolation Voltage	V_{IORM}	600	V_{peak}	DIN/EN/IEC EN60747-5-5
瞬态隔离电压 Transient isolation voltage	V_{IOTM}	5000	V_{peak}	DIN/EN/IEC EN60747-5-5
隔离电压 Isolation Voltage	Viso	> 3750	V_{rms}	For 1 min

极限参数 Absolute Maximum Ratings (Ta=25°C)

参数 Parameter		符号 Symbol	额定值 Rating	单位 Unit
发射端 Input	正向电流 Forward Current	I_F	50	mA
	反向电压 Reverse Voltage	V_R	6	V
	功耗 Power Dissipation	P_D	70	mW
	额定值降低因子(在 Ta = 90°C 以上) Power dissipation Derating factor (above Ta = 90°C)	P_{DD}	2.9	mW/°C
接收端 output	集电极功耗 Collector Power Dissipation	P_C	150	mW
	集电极电流 Collector Current	I_C	50	mA
	集电极-发射极电压 Collector-Emitter Voltage	V_{CEO}	80	V
	发射极-集电极电压 Emitter-Collector Voltage	V_{ECO}	6	V
隔离电压 Isolation Voltage		Viso	3750	V_{rms}
工作温度 Operating Temperature		T_{opr}	-55~+110	°C
存储温度 Storage Temperature		T_{stg}	-55~+125	°C
焊接温度 Soldering Temperature		T_{sol}	260	°C

产品特性参数 Electro-optical Characteristics (Ta=25°C)

参数 Parameter		符号 Symbol	条件 Condition	最小 Min.	典型 Typ.	最大 Max.	单位 Unit
发射端 Input	正向电压 Forward Voltage	V_F	$I_F=20\text{mA}$	-	1.2	1.4	V
	反向电流 Reverse Current	I_R	$V_R=4\text{V}$	-	-	10	μA
	输入电容 Terminal Capacitance	C_t	$V=0, f=1\text{KHz}$	-	30	250	pF
接收端 Output	集电极暗电流 Collector Dark Current	I_{CEO}	$V_{CE}=20\text{V}$	-	-	100	nA
	集电极-发射极击穿电压 Collector-Emitter Breakdown Voltage	BV_{CEO}	$I_C=0.1\text{mA}, I_F=0\text{mA}$	80	-	-	V
	发射极-集电极击穿电压 Emitter-Collector Breakdown Voltage	BV_{ECO}	$I_E=10\mu\text{A}, I_F=0$	6	-	-	V
传输特性 Transfer Characteristics	电流传输比 Current Transfer Ratio	CTR*	$I_F=5\text{mA}, V_{CE}=5\text{V}$	80	-	600	%
	集电极-发射极饱和压降 Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_F=20\text{mA}, I_C=1\text{mA}$	-	0.1	0.2	V
	隔离电阻 Isolation Resistance	R_{ISO}	DC500V, 40~60%R.H.	5×10^{10}	1×10^{11}	-	Ω
	隔离电容 Isolation capacitance	C_{ISO}	$V=0, f=1\text{MHz}$	-	0.6	1.0	pF
	截止频率 Cut-off Frequency	F_c	$V_{CE}=5\text{V}, I_C=2\text{mA}, R_L=100\Omega, -3\text{dB}$	-	80	-	kHz
	上升时间 Rise Time	T_r	$V_{CE}=2\text{V}, I_C=2\text{mA}, R_L=100\Omega$	-	4	18	μs
	下降时间 Fall Time	T_f	$V_{CE}=2\text{V}, I_C=2\text{mA}, R_L=100\Omega$	-	3	18	μs

注*: 电流传输比= $I_C/I_F \times 100\%$ 。Note*: $CTR=I_C/I_F \times 100\%$ 。电流传输比分档表 CTR Classification Table ($I_F=5\text{mA}, V_{CE}=5\text{V}, T_a=25^\circ\text{C}$)

代码 Code	最小值 Min.	最大值 Max.
A	80	160
B	130	260
C	200	400
D	300	600
E	100	200
F	150	300
None	80	600

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典型光电特性曲线 Typical Electro-Optical Characteristics Curves

Fig.1 Current Transfer Ratio vs Forward Current

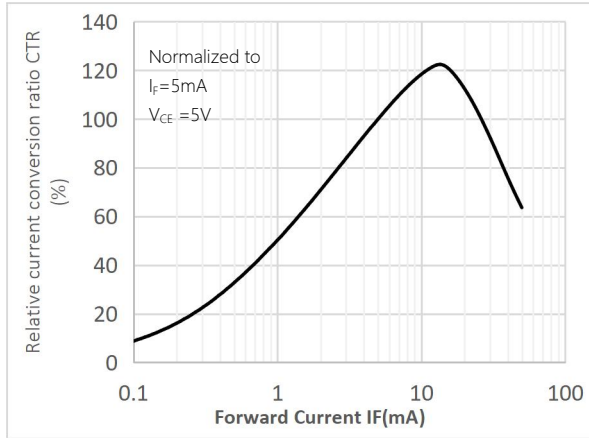


Fig.2 Forward Current vs. Forward Voltage

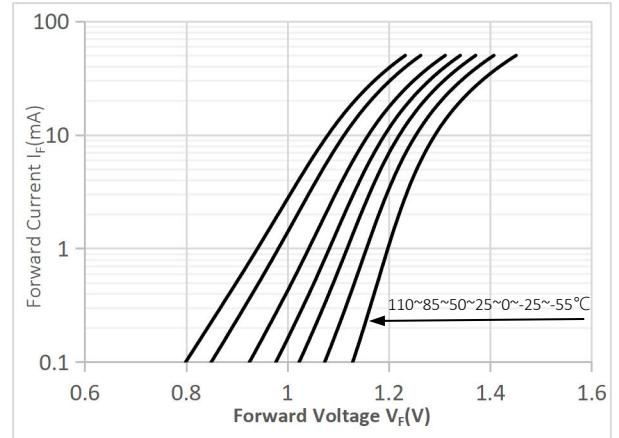


Fig.3 Collector Current vs. Collector-emitter Voltage

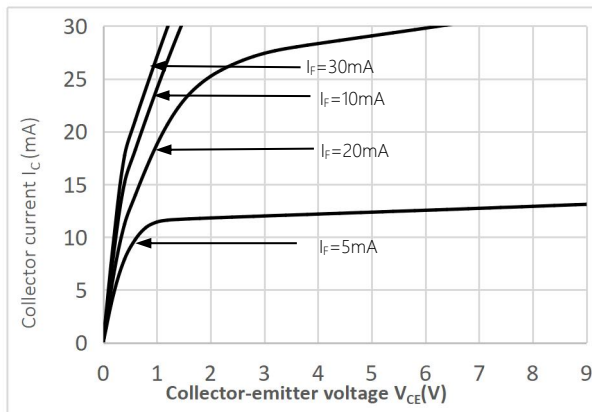


Fig.4 Relative Current Transfer Ratio vs. Ambient Temperature

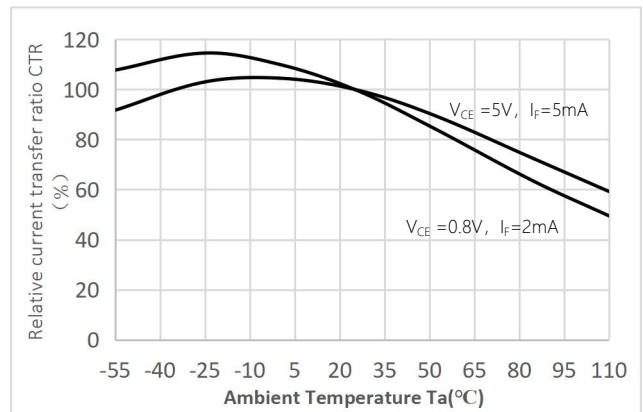


Fig.5 Collector-emitter Saturation Voltage vs. Ambient Temperature

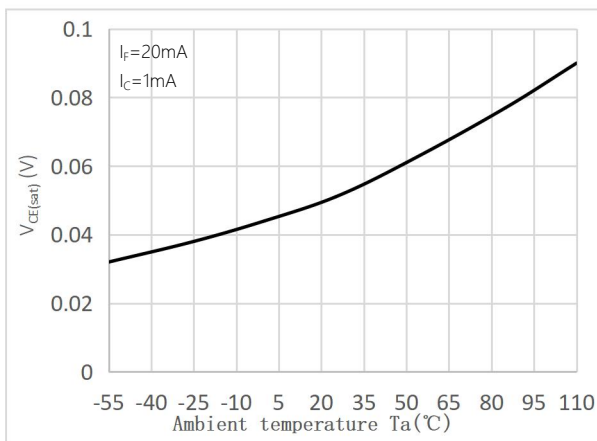
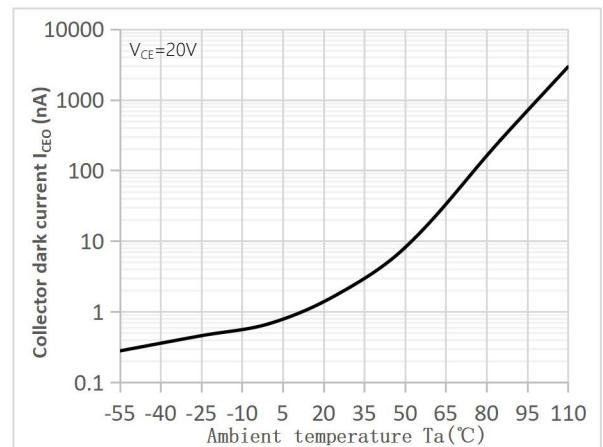


Fig.6 Collector Dark Current vs Ambient Temperature



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Fig.7 Response Time vs. Load Resistance

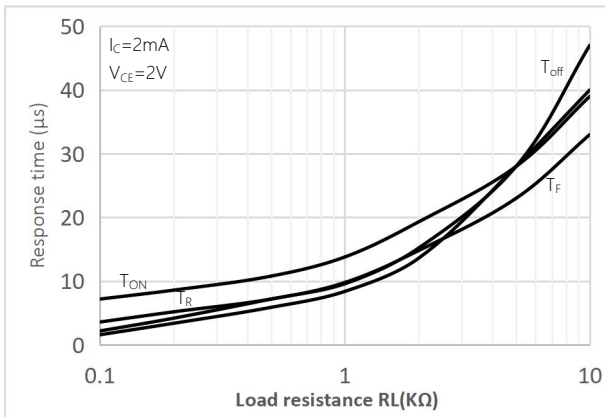


Fig.9 Collector-emitter Saturation Voltage vs Forward Current

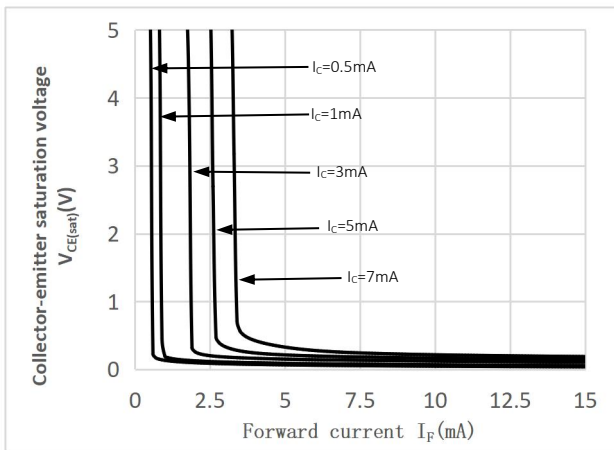


Fig.8 Frequency Response

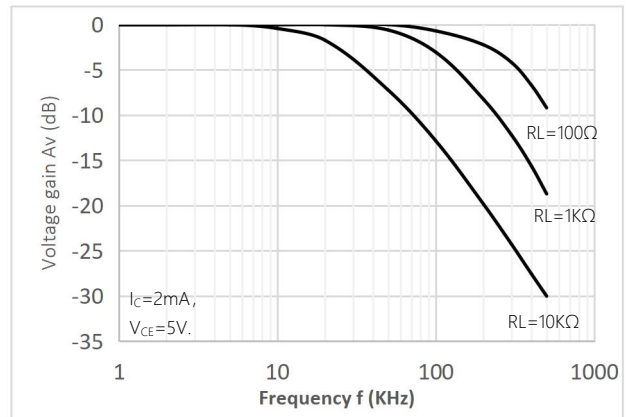
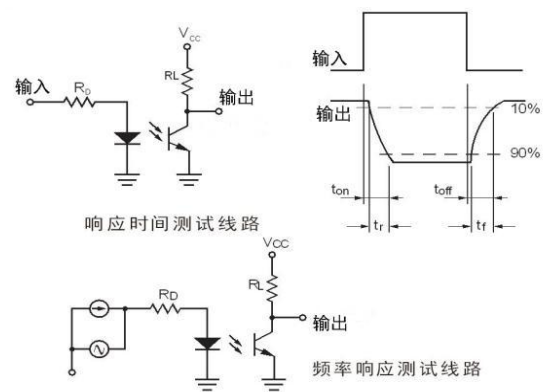


Fig.10 Switching Time Test Circuit & Waveforms

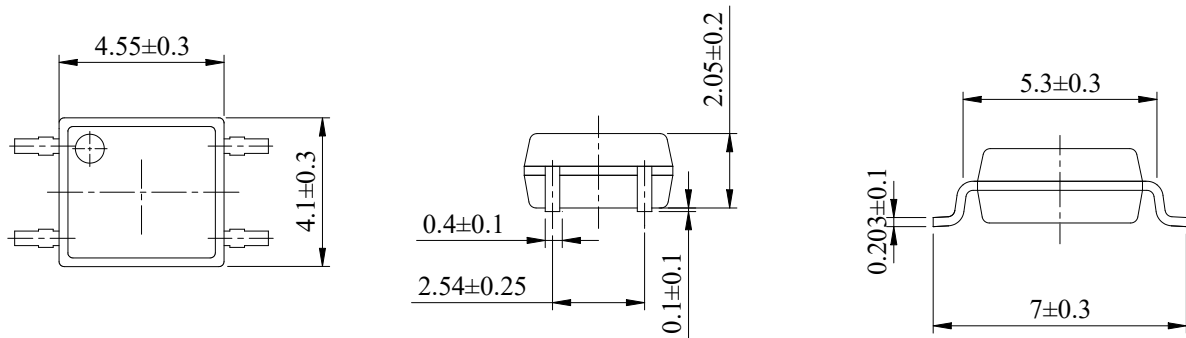


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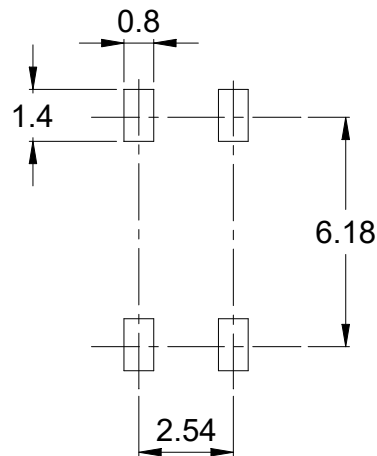
外形尺寸 Outline Dimensions

SOP4



单位 Unit: mm

建议焊盘布局 Recommended Pad Layout

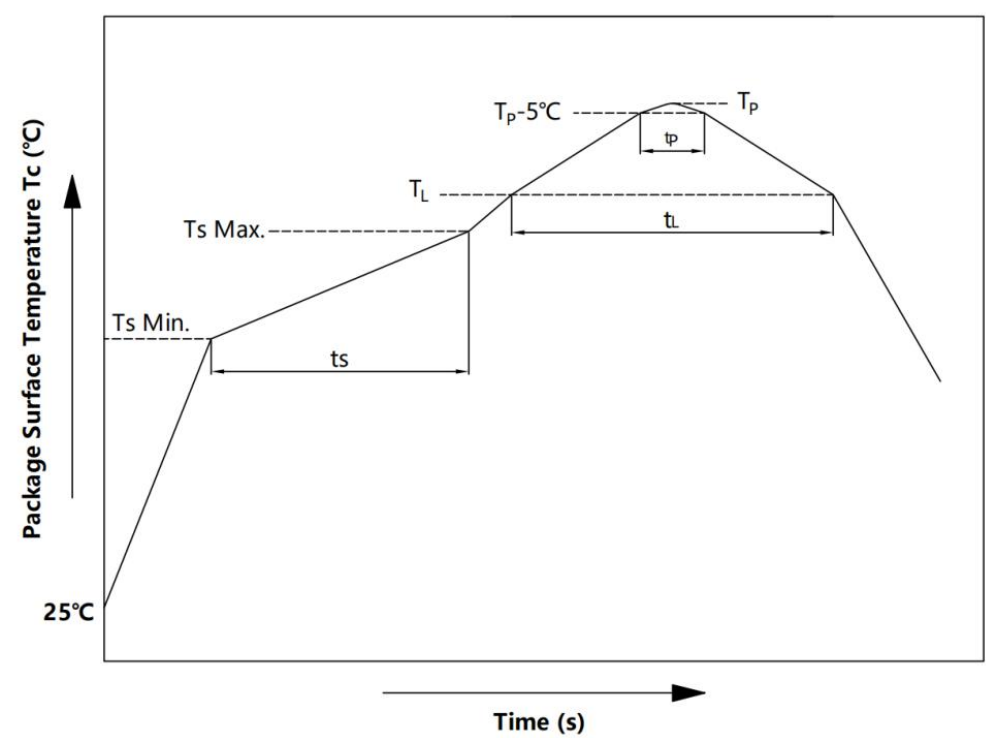


单位 Unit: mm

注：上图为产品正视图。

Note: The picture above is the front view of the product.

回流焊温度曲线图 Solder Reflow Profile

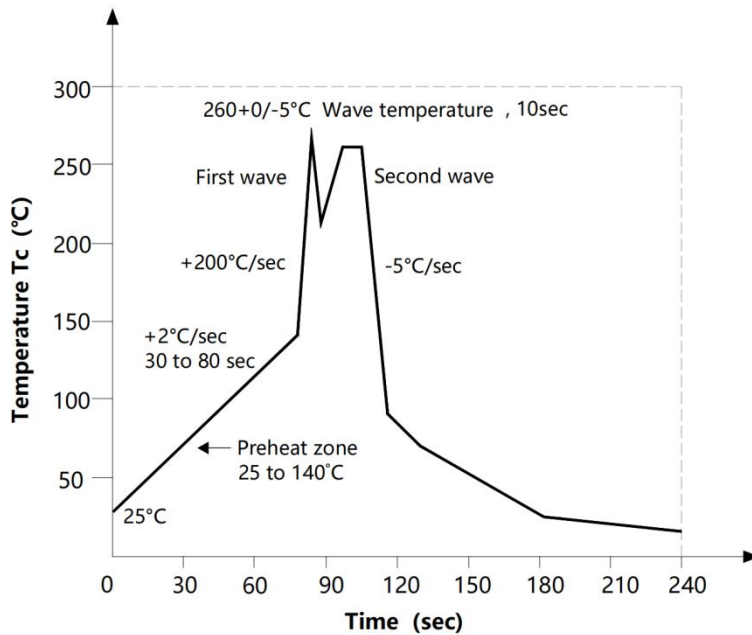


项目 Item	符号 Symbol	最小值 Min.	最大值 Max.	单位 Unit
预热温度 Preheat Temperature	T_s	150	200	$^{\circ}\text{C}$
预热时间 Preheat Time	t_s	60	120	s
升温速率 Ramp-Up Rate (T_L to T_P)	-	-	3	$^{\circ}\text{C/s}$
液相线温度 Liquidus Temperature	T_L	217		$^{\circ}\text{C}$
时间高于 T_L Time Above T_L	t_L	60	150	s
峰值温度 Peak Temperature	T_P	-	260	$^{\circ}\text{C}$
T_c 在 (T_P-5) 和 T_P 之间的时间 Time During Which T_c Is Between (T_P-5) and T_P	t_p	-	30	s
降温速率 Ramp-down Rate(T_P to T_L)	-	-	6	$^{\circ}\text{C/s}$

注 Note:

建议在所示的温度和时间条件下进行回流焊，最多不能超过三次；
Reflow soldering is recommended at the temperatures and times shown, no more than three times;

波峰焊温度曲线图 Wave Soldering Profile



手工烙铁焊接 Soldering with hand soldering iron

A. 手工烙铁焊仅用于产品返修或样品测试;

Hand soldering iron is only used for product rework or sample testing;

B. 手工烙铁焊要求: 温度 $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, 时间 $\leq 3\text{s}$ 。

Hand soldering iron requirements: Temperature: $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, within 3s.

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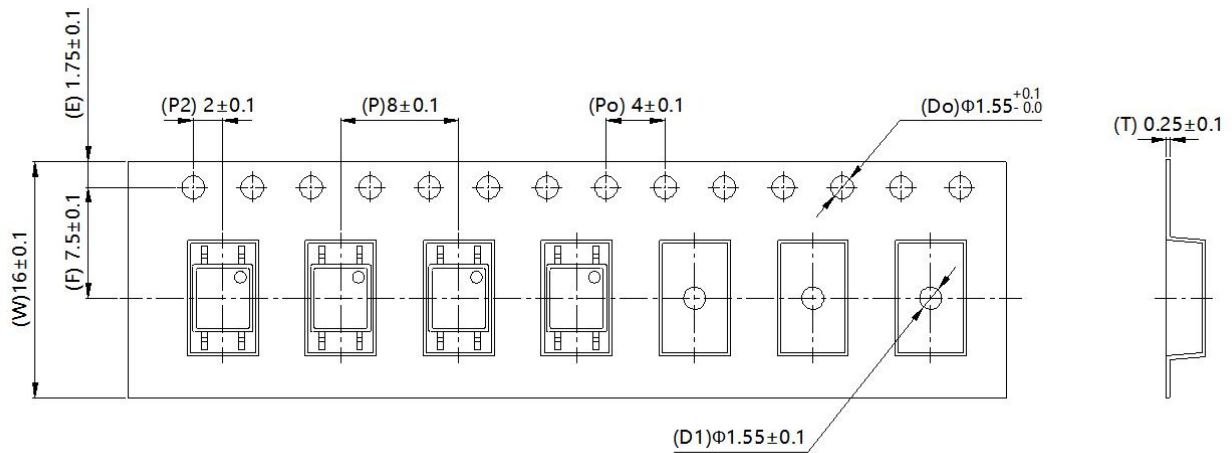
包装 Packing

■ 汇总表 Summary table

封装形式	包装方式	盘数量	盒数量	箱数量	静电袋规格	盒规格	箱(双瓦楞)规格	备注
SOP4	卷盘 ($\phi 330\text{mm}$ 蓝盘)	3000 只/盘	2 盘/盒	10 盒/箱	450*390*0.1mm	340*60*340mm	620*360*365mm	首尾端空至少 200mm
Package Type	Packing Form	Quantity per Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
SOP4	Reel ($\phi 330\text{mm}$ Blue)	3000 pcs /reel	2 reels /box	10 boxes /ctn	450*390*0.1mm	340*60*340mm	620*360*365mm	Guard band 200mm min.

■ 编带包装 Tape & Reel

- 1) 每卷数量: 3000 只。
Qty/reel: 3000 pcs.
- 2) 每箱数量: 60000 只。
Qty/ctn: 60000 pcs.
- 3) 内包装: 每盒 2 盘。
Inner packing: 2 reels/box.
- 4) 示意图 Schematic:



单位 Unit: mm

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